Technical Data **Ultra LDO 2A Linear Regulator With Adjustable & Bypass Pin**
Data Sheet N1579, Rev. -

Description:

A low noise, high PSRR and ultra low dropout linear regulator SULR1221 is optimized for low ESR ceramic capacitors operation with 2A continuous current. The SULR1221 is designed for portable and wireless devices with demanding performance and space requirements

The SULR1221 offers high precision output voltage of ±2% tolerance. Output voltage can also be adjusted for those other than the preset values.

A noise bypass pin is available for further reduction of output noise. The bypass pin could be floating if it's unnecessary. At 2A load current and 5V output voltage, a 480mV dropout is performed. The quality of low quiescent current and low dropout voltage makes this device ideal for battery power applications. The high ripple rejection and low noise of the SULR1221 provide enhanced performances for critical applications.

In addition, a logic-level shutdown input is included, which reduce supply current to less than 0.01μA (typ.) in shutdown mode with fast turn-on time less than 100μs. The SULR1221's current limit and thermal protection provide protection against any overload condition that would create excessive junction temperatures.

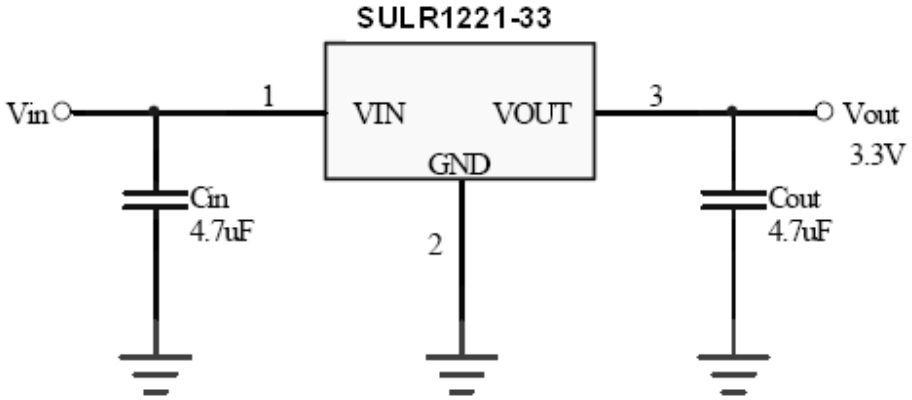
Features:

- **Guaranteed 2A Output Current.**
- **Fast Response in Line/Load Transient**
- **Wide Operating Voltage Ranges: 1.8V to 6.0V.**
- **0.01μA Shutdown Standby Current**
- **Low Quiescent Current: 30μA.**
- **Fixed: 1.8V, 2.5V, 3.3V, 5V Output Voltage.**
- **Adjustable Output Voltage are available from 0.8~5.5V.**
- **Low Dropout：550mV at 2A and 3.3V output voltage, 480mV at 2A and 5V output voltage.**
- **High PSRR：70dB at 1KHz.**
- **Active Low or High Shutdown Control. Current Limit and Thermal Protection.**
- **Available in ±2% Output Tolerance.**
- **Available in SOT-223 & TO-252(3 pin) & SOP- 8 Exposed Pad (Heat Sink) Package.**

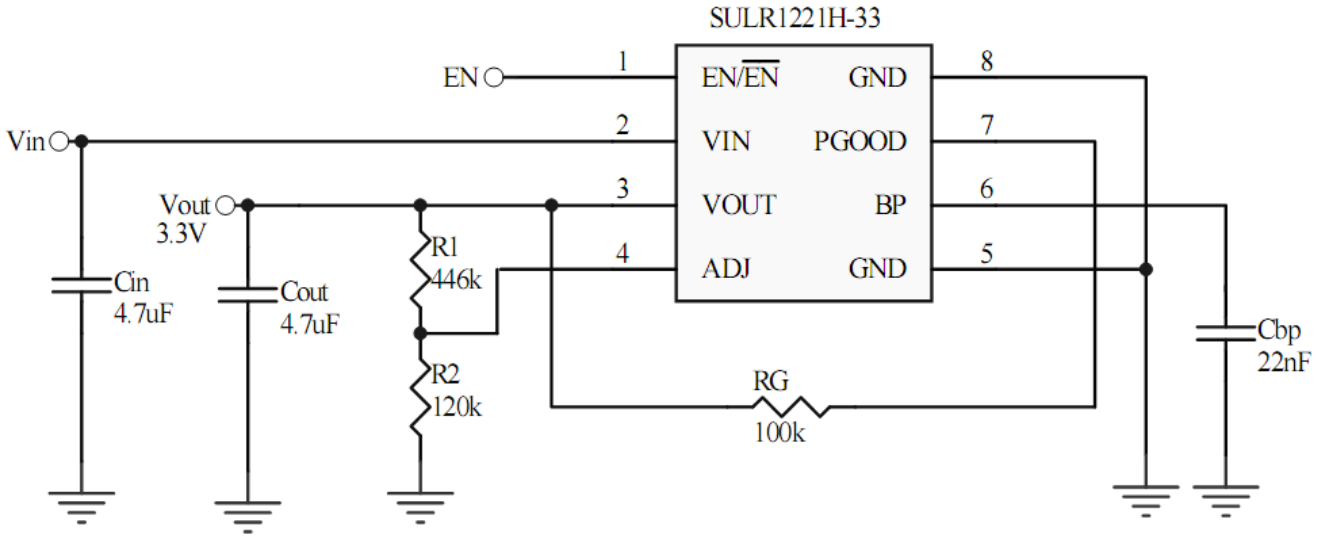
Applications:

- **LCD TV, LCD Monitor, DPF**
- **Networking**
- **STB**
- **DVD, HDD Driver**
- **Portable AV Equipment**
- **PC Peripherals**

Typical application circuit:



Fixed Linear Regulator



Adjustable Linear Regulator in SOP-8 Package

Technical Data **Ultra LDO 2A Linear Regulator With Adjustable & Bypass Pin**
Data Sheet N1579, Rev. -

Ordering Information:

SULR1221-XXXXX

PACKING TYPE
TB: TUBE
TR: TAPING & REEL

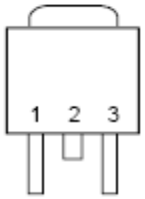
PACKAGING TYPE
T: TO-252
G: SOT-223
M: SOP-8

OUTPUT VOLTAGE
18: 1.8V
25: 2.5V
30: 3.0V
33: 3.3V
50: 5V
(Of a unit of 0.1V within 0.8~5.5V, additional voltage versions are available on demand)

PIN CONFIGURATION

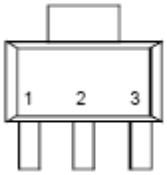
TO-252
TOP VIEW

1: ADJ (GND)
2: VOUT (TAB)
3: VIN



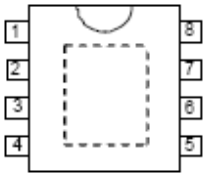
SOT-223
FRONT VIEW

1: ADJ (GND)
2: VOUT (TAB)
3: VIN



SOP-8 Exposed Pad (Heat Sink)
TOP VIEW

1: EN / $\overline{EN}$
2: VIN
3: VOUT
4: ADJ
5: GND (TAB)
6: BP
7: PG
8: GND (TAB)



Example: SULR1221-18GTR $\overline{EN}$
→1.8V Version, in SOT-223 Green Package & Tape & Reel Packing Type

Example: SULR1221-18TTR
→ 1.8V version in TO-252 Green Package &Taping & Reel Packing Type

Ordering Information (Continued)

SULR1221H-XXXXX

PACKING TYPE
TB: TUBE
TR: TAPING & REEL

PACKAGING TYPE
M: SOP-8

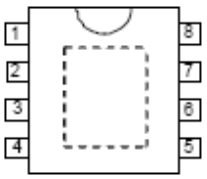
OUTPUT VOLTAGE
18: 1.8V
25: 2.5V
33: 3.3V
50: 5.0V
(Of a unit of 0.1V within 0.8~5.5V, additional voltage versions are available on demand)

ENABLE TYPE
L: Chip Enable Low
H: Chip Enable High

PIN CONFIGURATION

SOP-8 Exposed Pad (Heat Sink)
TOP VIEW

1: EN / $\overline{EN}$
2: VIN
3: VOUT
4: ADJ
5: GND (TAB)
6: BP
7: GND (TAB)
8: GND (TAB)



Absolute Maximum Ratings:

Input Voltage ……7V
EN Pin Voltage ……7V
Noise Bypass Terminal Voltage ……7V
Operating Temperature Range ……–40°C to 85°C
Maximum Junction Temperature ……150°C
Storage Temperature Range ……–65°C ~ 150°C
Lead Temperature (Soldering) 10 sec. ……260°C
Thermal Resistance Junction to Case TO-252 ……8°C/W
SOT-223……15°C/W
SOP-8 (Exposed Pad*)..... 15ºC /W
Thermal Resistance Junction to Ambient
(Assume no ambient airflow, no heatsink) SOT-223……130°C/W
TO-252 ……100°C/W
(Assume no ambient airflow) SOP-8 (Exposed Pad*)……60ºC /W

Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.
* The package is placed on a two layers PCB with 2 ounces copper and 2 square inch, connected by 8 vias

Electrical Characteristics

(C_{IN} = C_{out} = 4.7μF(Note 1), C_{BP} = 22nF, V_{IN} = V_{OUT} + 1V, T_J=25℃, unless otherwise specified)(Note 2)

PARAMETER	TEST CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Input Voltage (Note 3)		V_{IN}	1.8		6	V
Output Voltage Tolerance	I_{OUT} =1mA	V_{OUT}	-2		2	%
Continuous Output Current	V_{IN} ≧2.3V	I_{OUT}	2			A
Quiescent Current	Chip Enable Low, V_{EN} ≦0.4V, I_{OUT} = 0 mA Chip Enable High, V_{EN} ≧1.6V, I_{OUT} = 0 mA	I_Q		30	50	μA
GND Pin Current	Chip Enable Low, V_{EN} ≦0.4V, I_{OUT} = 2A Chip Enable High, V_{EN} ≧1.6V, I_{OUT} = 2A	I_{GND}		30	50	μA
Standby Current	Chip Enable Low, V_{EN} = V_{IN} Chip Enable High, V_{EN} = 0	I_{STBY}		0.01	0.5	μA
Output Current Limit	R_{LOAD} = 0.1Ω	I_{IL}	2.2	3.0	3.9	A
Current Fold Back	R_{LOAD} = 0.1Ω	I_{CFB}		1.0		A
Dropout Voltage	I_{OUT} = 2A, V_{OUT} =1.8V	V_{DROP}		700	900	mV
	I_{OUT} = 2A, V_{OUT} =3.3V			550	700	
	I_{OUT} = 2A, V_{OUT} =5.0V			480	600	
Line Regulation	V_{IN} = V_{OUT} + 1V to 6V, I_{OUT} =1mA	ΔV_{LIR}		3	15	mV
Load Regulation	I_{OUT} =1mA to 2A	ΔV_{LOR}		5	15	mV
Ripple Rejection	f=1KHz, Ripple=0.5Vp-p,	PSRR		70		dB
Temperature Coefficient		TC		50		ppm/℃
Thermal Shutdown Temperature	V_{IN} = V_{OUT} + 1V	T_{SD}		150		℃
Thermal Shutdown Hysteresis		ΔT_{SD}		20		℃
ADJ Pin Specifications						
ADJ Pin Current	V_{ADJ} = V_{REF}	I_{ADJ}		10	100	nA
ADJ Pin Threshold		$VTH_{(ADJ)}$	0.05	0.1	0.2	V
Reference Voltage Tolerance		V_{REF}	0.686	0.7	0.714	V

Electrical Characteristics (Continued)

PARAMETER	TEST CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Shutdown Pin Specifications						
Shutdown Pin Current	V_{EN} = V_{IN} or GND	I_{EN}		0	0.5	μA
Shutdown Exit Delay Time	I_{OUT} = 30mA	Δt		100		μS
Max Output Discharge Resistance to GND during Shutdown		RDSON_ CLMP		20	100	Ω
Shutdown Input Threshold	Chip Enable Low, Output OFF, V_{IN} = 1.6V to 6V Chip Enable High, Output ON, V_{IN} = 1.6V to 6V	V_{ENH}	1.6			V
	Chip Enable Low, Output ON, V_{IN} = 1.6V to 6V Chip Enable High, Output OFF, V_{IN} = 1.6V to 6V	V_{ENL}			0.4	
Power Good Specifications						
PGOOD Rise Threshold				90	93	%
PGOOD Hysteresis			3	10		%
PGOOD Sink Capability	I_{PGOOD}=10mA			0.2	0.4	V
PGOOD Delay			0.5		5	ms

Note 1: In the case of V_{out} <1.8V, 10μF C_{out} is recommended.
Note 2: Specifications are production tested at TA=25°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).
Note 3: V_{in}(min) is the higher value of Vout + Dropout Voltage or 1.8V.

Typical Performance Characteristics

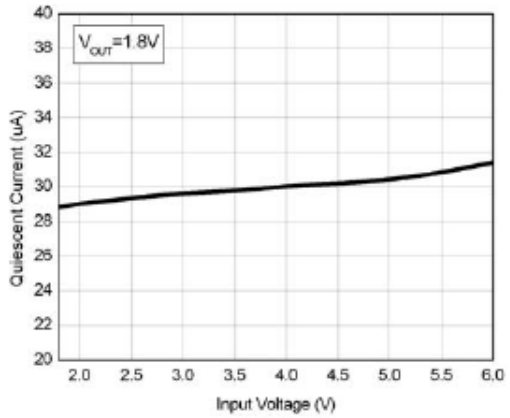


Fig. 1 Quiescent Current vs. Input Voltage at V_{OUT}=1.8V

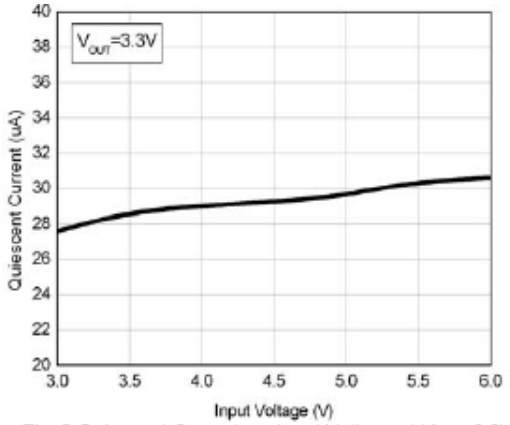


Fig. 2 Quiescent Current vs. Input Voltage at V_{OUT}=3.3V

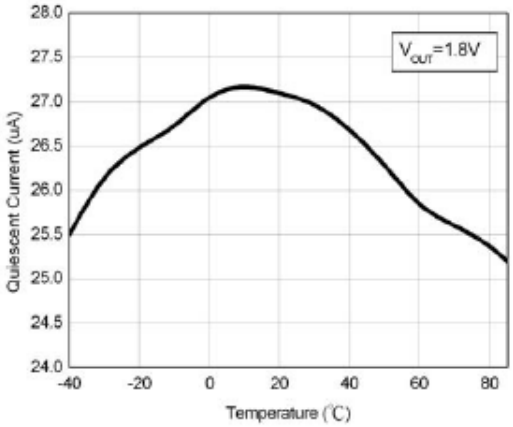


Fig. 3 Quiescent Current vs. Temperature at V_{OUT}=1.8V

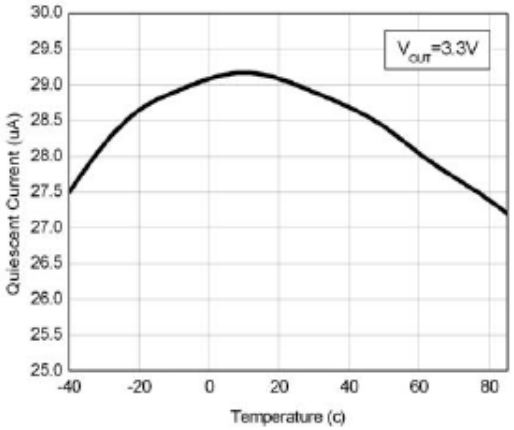


Fig. 4 Quiescent Current vs. Temperature at V_{OUT}=3.3V

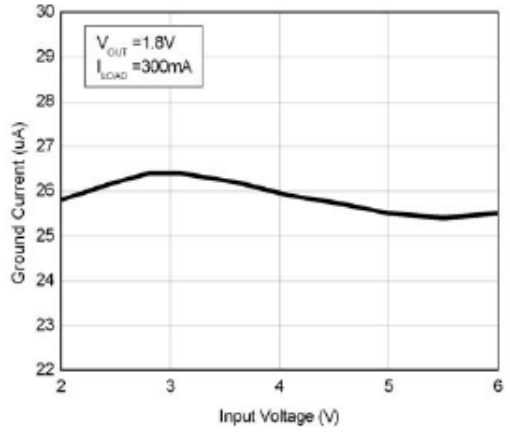


Fig. 5 Ground Current vs. Input Voltage at V_{OUT}=1.8V

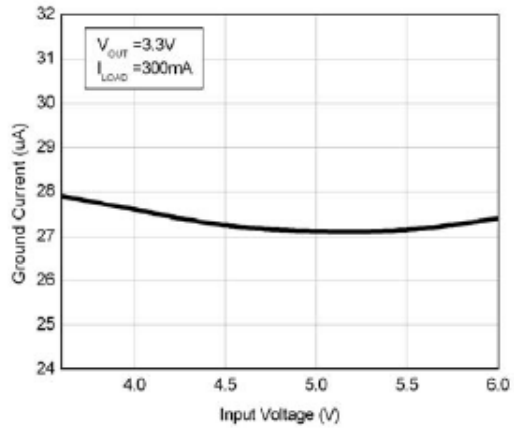


Fig.6 Ground Current vs. Input Voltage at V_{OUT}=3.3V

Typical Performance Characteristics (Continued)

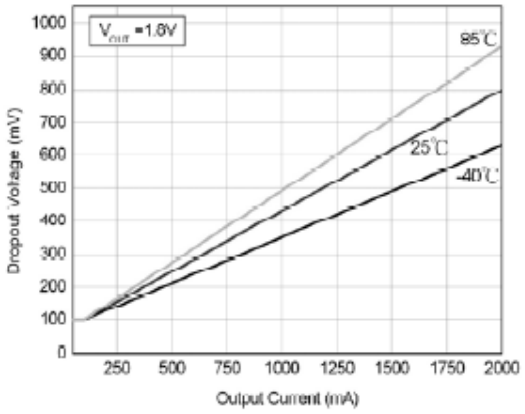


Fig.7 Dropout Voltage at V_{OUT}=1.8V

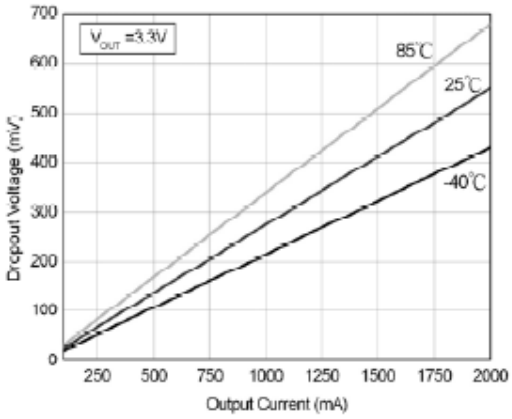


Fig. 8 Dropout Voltage at V_{OUT}=3.3V

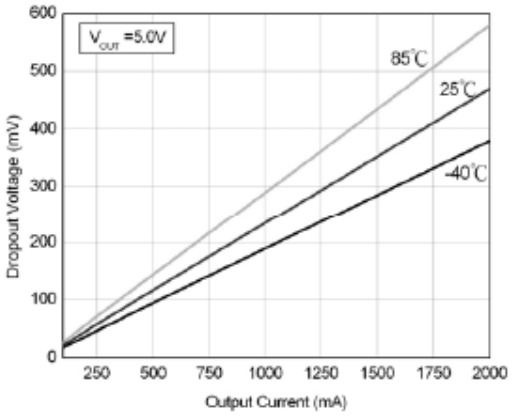


Fig. 9 Dropout Voltage at V_{OUT}=5.0V

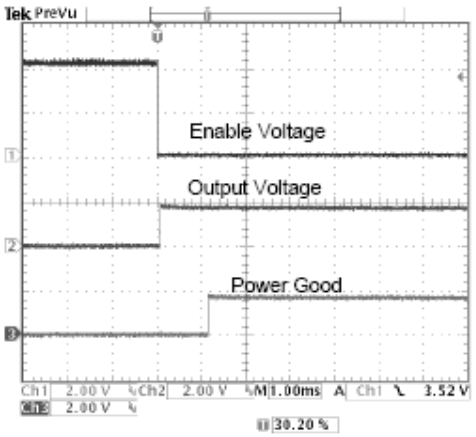


Fig.10 Enable Startup at V_{OUT}=1.8V

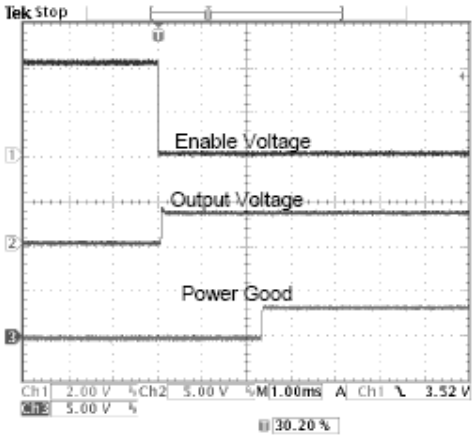


Fig.11 Enable Startup at V_{OUT}=3.3V

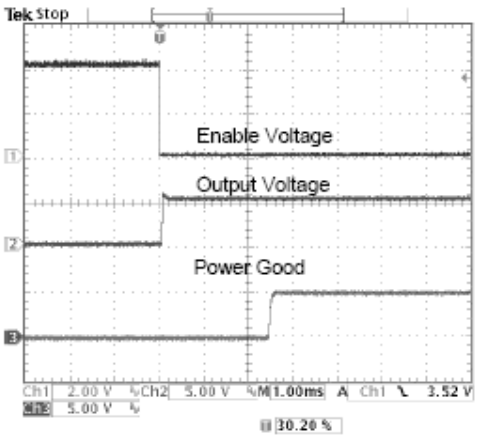


Fig.12 Enable Startup at V_{OUT}=5.0V

Typical Performance Characteristics (Continued)

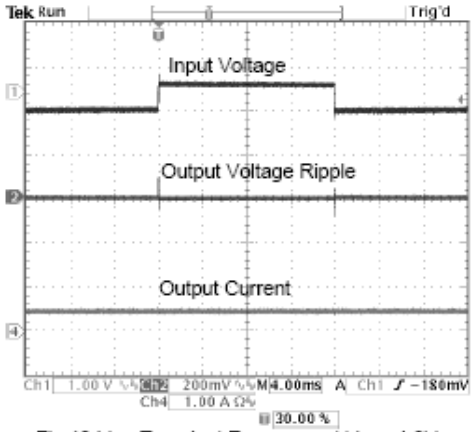


Fig.13 Line Transient Response at V_{OUT}=1.8V

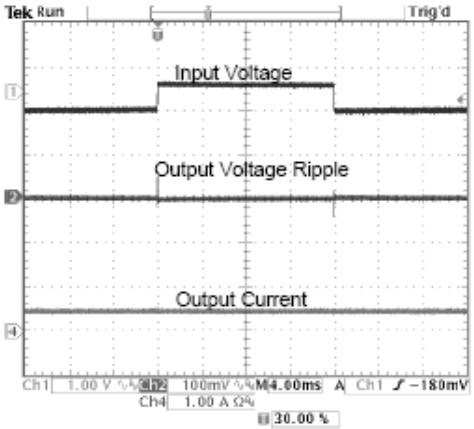


Fig. 14 Line Transient Response at V_{OUT}=3.3V

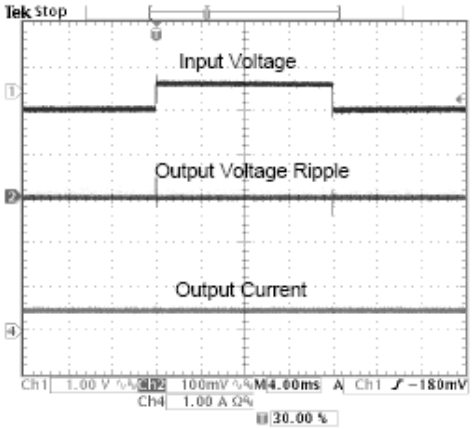


Fig. 15 Line Transient Response at V_{OUT}=5.0V

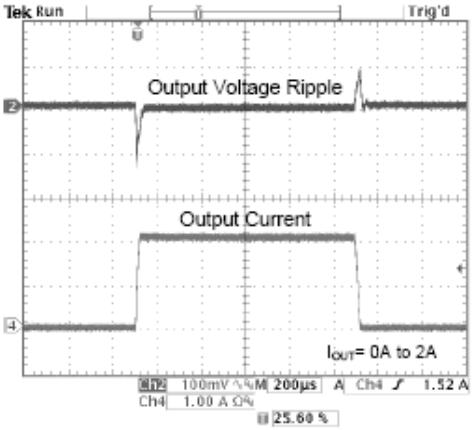


Fig.16 Load Transient Response at V_{OUT}=1.8V

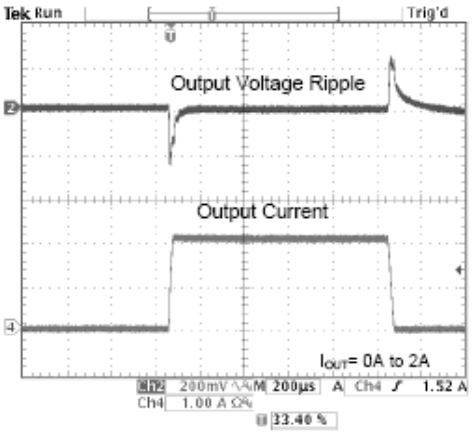


Fig.17 Load Transient Response at V_{OUT}=3.3V

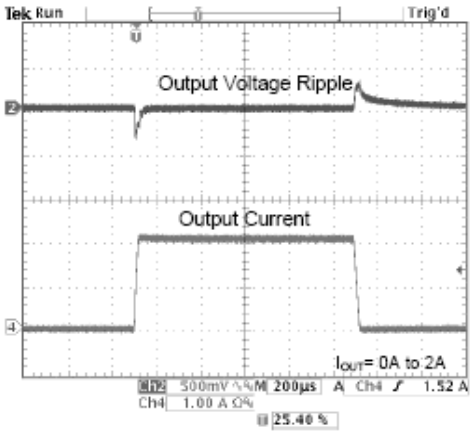


Fig.18 Load Transient Response at V_{OUT}=5.0V

Typical Performance Characteristics (Continued)

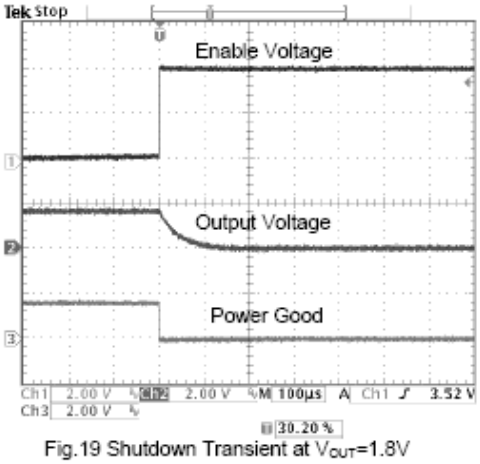


Fig.19 Shutdown Transient at V_{OUT}=1.8V

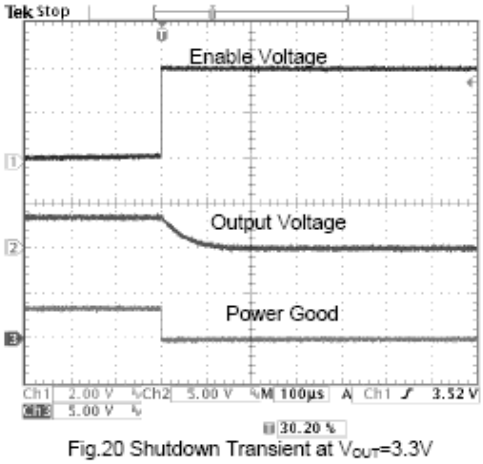


Fig.20 Shutdown Transient at V_{OUT}=3.3V

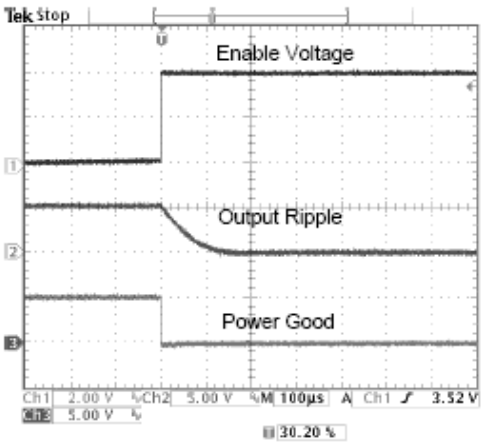


Fig. 21 Shutdown Transient at V_{OUT}=5.0V

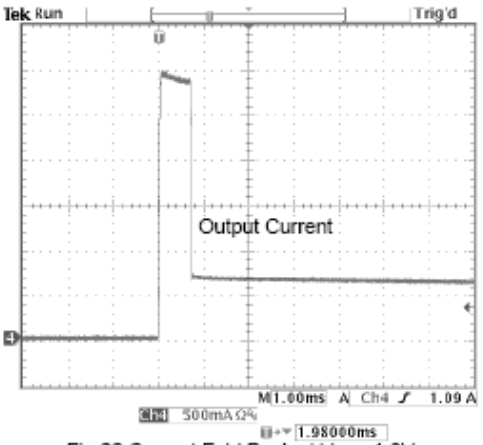


Fig.22 Current Fold Back at V_{OUT}=1.8V

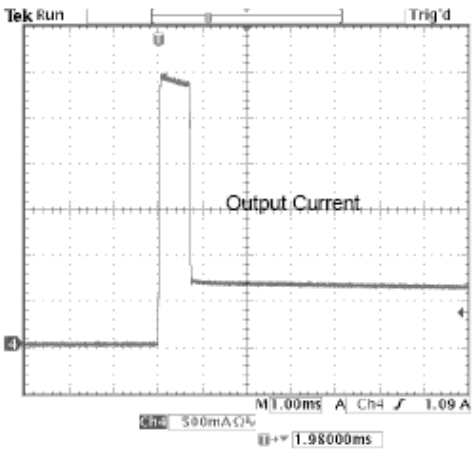


Fig. 23 Current Fold Back at V_{OUT}=3.3V

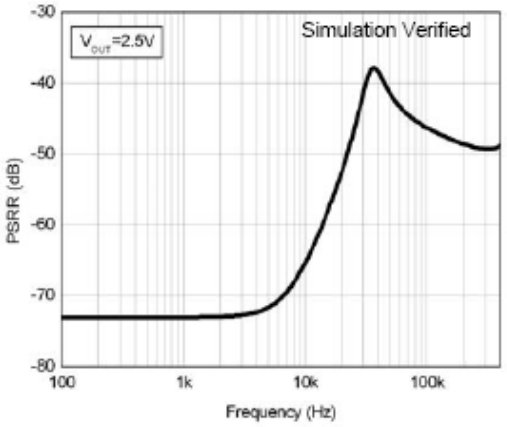
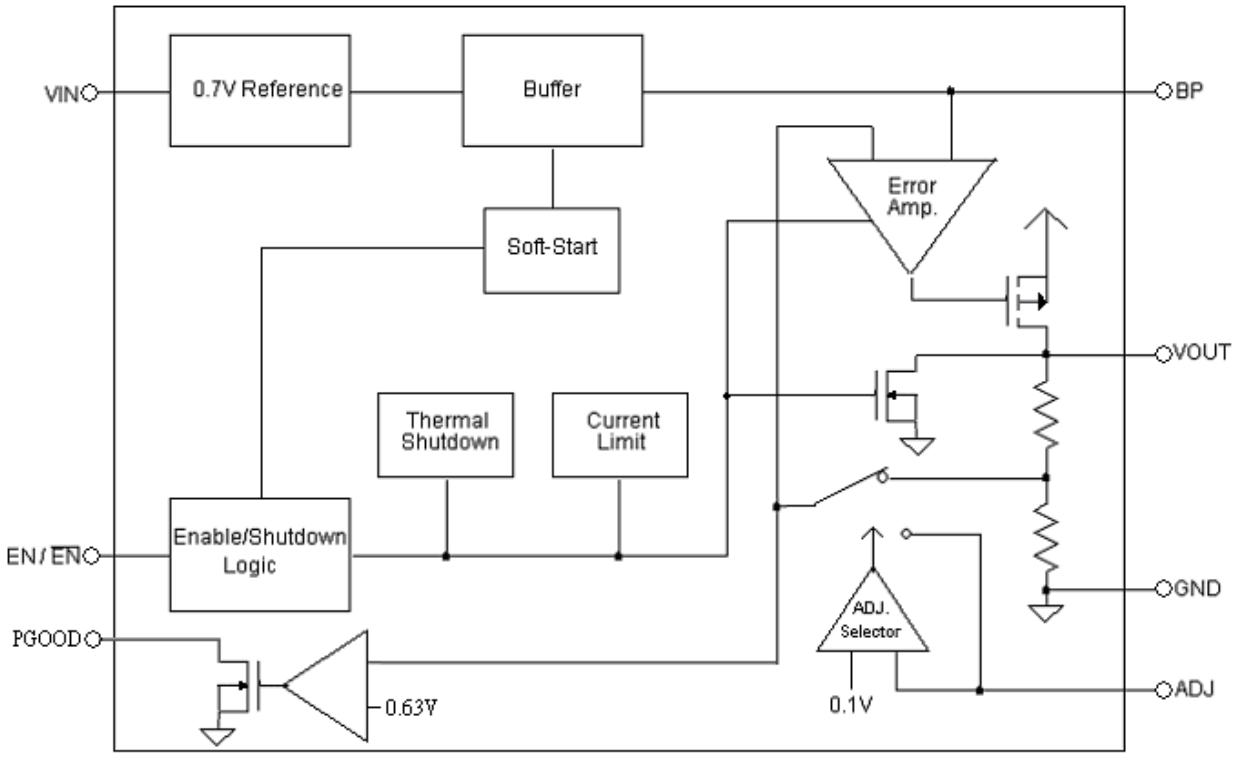


Fig.24 PSRR Curve

Block Diagram



Pin Descriptions

VIN – Power supply input pin. Bypass with a 4.7µF capacitor to GND
GND – Ground.
VOUT – Regulator Output pin. Sources up to 2A.
$\overline{EN}$ (5 Pin and 8 Pin) – Chip Enable (Active Low). This pin isn't allowed to float.
EN (5 Pin and 8 Pin) – Chip Enable (Active High). This pin isn't allowed to float.
BP (5 Pin and 8 Pin) – Bypass pin. It can connect to external 22nF capacitor to GND to reduce output noise. The bypass pin could be floating if it's unnecessary.
PGOOD (8 Pin) – Power Good open Drain output.
ADJ (5 Pin and 8 Pin) –The output voltage can either be set by the internal feedback resistors when this pin is grounded, or be set by the external feedback resistors when using a resistive divider.

Application Information

The SULR1221 is a high performance linear regulator that provides low-dropout voltage and low quiescent-current. The device is available in an adjustable version and fixed output voltages ranging from 0.8V to 5.5V, and the device can supply loads up to 2A.

SHUTDOWN

By connecting $\overline{EN}$(EN) pin to V_{IN}(ground), the SULR1221 can be shut down to reduce the supply current to 0.01μA(typ.). At this operation mode, the output voltage of SULR1221 is equal to 0V.

CURRENT LIMIT

The SULR1221 includes a current limiter, which monitors and controls the maximum output current. If the output is overloaded or shorted to ground, this can protect the device from being damaged.

THERMAL PROTECTION

The SULR1221 includes a thermal-limiting circuit, which is designed to protect the device against overload condition. When the junction temperature exceeds T_J=150ºC, the thermal-limiting circuit turns off the pass transistor and allows the IC to cool. For continuous load condition, maximum rating of junction temperature must not be exceeded.

INPUT-OUTPUT CAPACITORS

Linear regulators require input and output capacitors to maintain stability. Input capacitor at a 4.7μF Output capacitor with a 4.7μF or 10μF (V_{out} <1.8V, 10μF C_{out} is recommended) ceramic output capacitor is recommended. When choosing the input and output ceramic capacitors, X5R and X7R types are recommended because they retain their capacitance over wider ranges of voltage and temperature than other types.

NOISE BYPASS CAPACITOR

A 22nF bypass capacitor at BP pin can reduce output voltage noise. The bypass pin can be floating if it's unnecessary.

OUTPUT VOLTAGE PROGRAMMING

Its internal feedback resistors can set the output voltage of SULR1221 linear regulator when the ADJ pin is grounded. In addition, the output voltage of SULR1221 linear regulator can be set by the external feedback resistors when connecting a resistive divider R_1 and R_2. While connecting a resistive divider, V_{OUT} can be calculated as:

$$V_{OUT} = 0.7 \times \{1 + \frac{R_1}{R_2}\}$$

The resistive divider should sit as close to ADJ pin as possible.

POWER DISSIPATION

The maximum power dissipation of SULR1221 depends on the thermal resistance of its case and circuit board, the temperature difference between the die junction and ambient air, and the rate of airflow. The rate of temperature rise is greatly affected by the mounting pad configuration on the PCB, the board material, and the ambient temperature. When the IC mounting with good thermal conductivity is used, the junction temperature will be low even when large power dissipation applies.

The power dissipation across the device is $P = I_{OUT}(V_{IN}-V_{OUT})$.

The maximum power dissipation is:

$$P_{MAX} = \frac{(T_{J\text{-}max} - T_A)}{R_{\Theta JA}}$$

Where $T_{J\text{-}max}$ is the maximum allowable junction temperature (150°C), and T_A is the ambient temperature suitable in application.
As a general rule, the lower temperature is, the better reliability of the device is. So the PCB mounting pad should provide maximum thermal conductivity to maintain low device temperature.

LAYOUT CONSIDERATION
Connect the bottom-side pad to a large ground plane. Use as much copper as possible to decrease the thermal resistance of the device.

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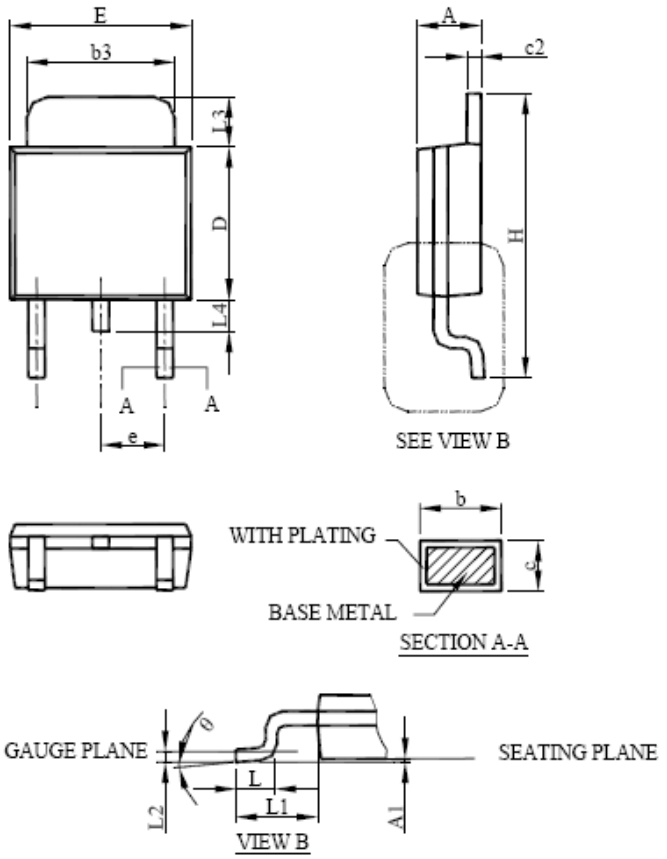
Physical Dimensions

TO-252 (unit: mm)



SYMBOL	TO-252-3L	
	MILLIMETERS	
	MIN.	MAX.
A	2.19	2.38
A1	0.00	0.13
b	0.64	0.89
b3	4.95	5.46
c	0.46	0.61
c2	0.46	0.89
D	5.33	6.22
E	6.35	6.73
e	2.28 BSC	
H	9.40	10.41
L	1.40	1.78
L1	2.67 REF	
L2	0.51 BSC	
L3	0.89	2.03
L4	--	1.02
θ	0°	8°

Note:
1. Refer to JEDEC TO-252AA and AB.
2. Dimension “E” do not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.
3. Dimension "D" does not include inter-lead flash or protrusions.
4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

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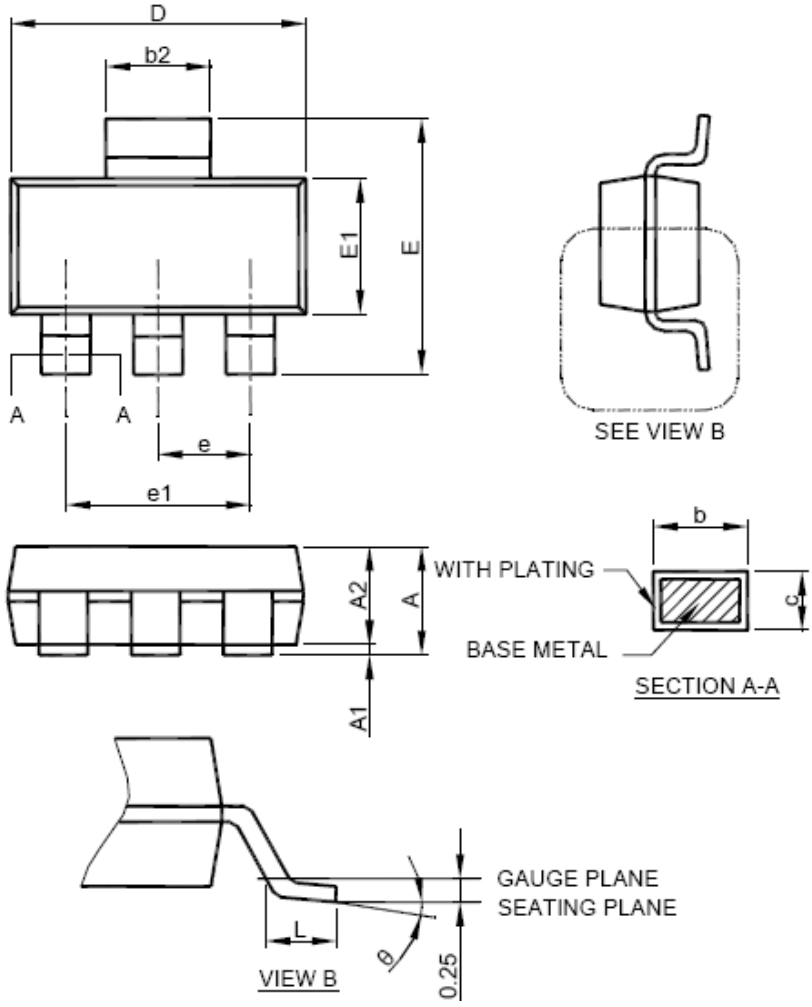
SOT-223(unit: mm)



SYMBOL	SOT-223	
	MILLIMETERS	
	MIN.	MAX.
A		1.80
A1	0.02	0.10
A2	1.55	1.65
b	0.66	0.84
b2	2.90	3.10
c	0.23	0.33
D	6.30	6.70
E	6.70	7.30
E1	3.30	3.70
e	2.30 BSC	
e1	4.60 BSC	
L	0.90	
θ	0°	8°

Note: 1. Refer to JEDEC TO-261AA.
2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side .
3. Dimension "E1" does not include inter-lead flash or protrusions.
4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

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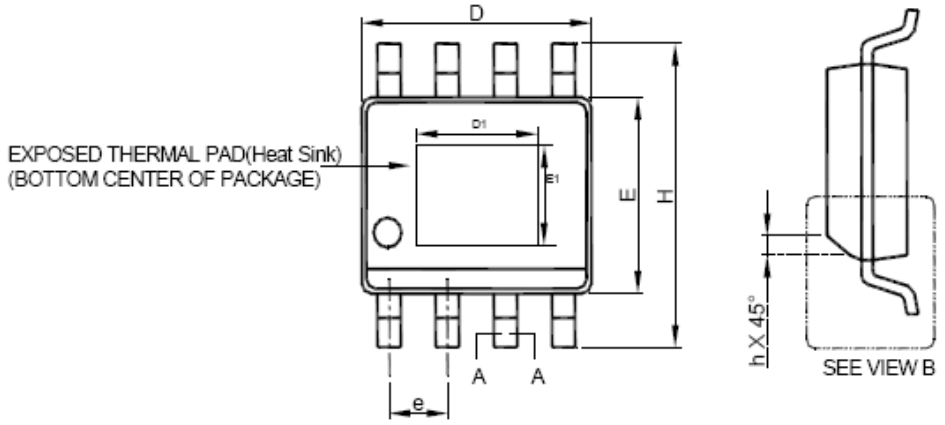
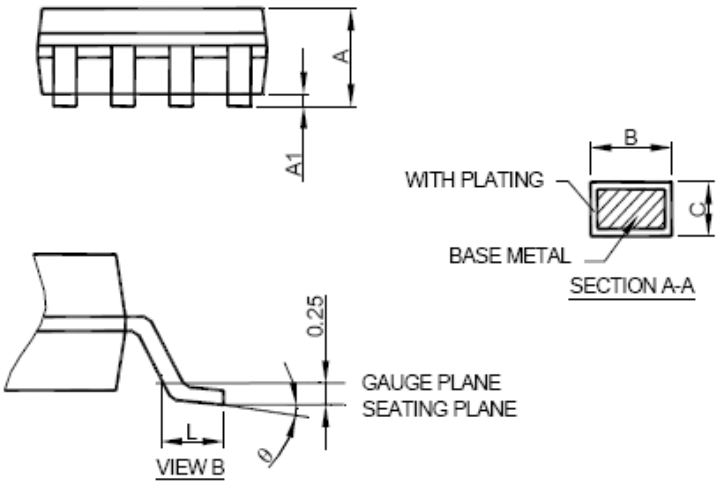
SOP-8 (unit: mm)





SYMBOL	SOP-8 Exposed Pad(Heat Sink)	
	MILLIMETERS	
	MIN.	MAX.
A	1.35	1.75
A1	0.00	0.15
B	0.31	0.51
C	0.17	0.25
D	4.80	5.00
D1	1.50	3.50
E	3.80	4.00
E1	1.0	2.55
e	1.27 BSC	
H	5.80	6.20
h	0.25	0.50
L	0.40	1.27
θ	0°	8°

Note: 1. Refer to JEDEC MS-012E.
2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side .
3. Dimension "E" does not include inter-lead flash or protrusions.
4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

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